



US00D915358S

(12) **United States Design Patent** (10) **Patent No.:** **US D915,358 S**  
**Ma** (45) **Date of Patent:** **\*\* Apr. 6, 2021**

(54) **EARPHONES**  
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(\*\*) Term: **15 Years**

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(21) Appl. No.: **29/758,208**  
(22) Filed: **Nov. 12, 2020**  
(30) **Foreign Application Priority Data**  
Oct. 28, 2020 (CN) ..... 202030645674.3  
(51) **LOC (13) Cl.** ..... **14-01**  
(52) **U.S. Cl.**  
USPC ..... **D14/223**  
(58) **Field of Classification Search**  
USPC ..... D14/223, 205, 229; D13/108; D24/174;  
128/864, 865, 866; 381/380, 381;  
320/113; 455/90.3, 575.1, 569.1  
CPC ..... H04R 1/10; H04R 25/00; H04R 25/02;  
H04R 1/1066; H04R 1/1016; H04R  
5/033; H04R 5/0335; H04R 1/105; H04R  
1/1058; H04R 1/1083; B65D 25/10;  
B65D 85/00  
See application file for complete search history.

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*Primary Examiner* — Paula Allen Greene

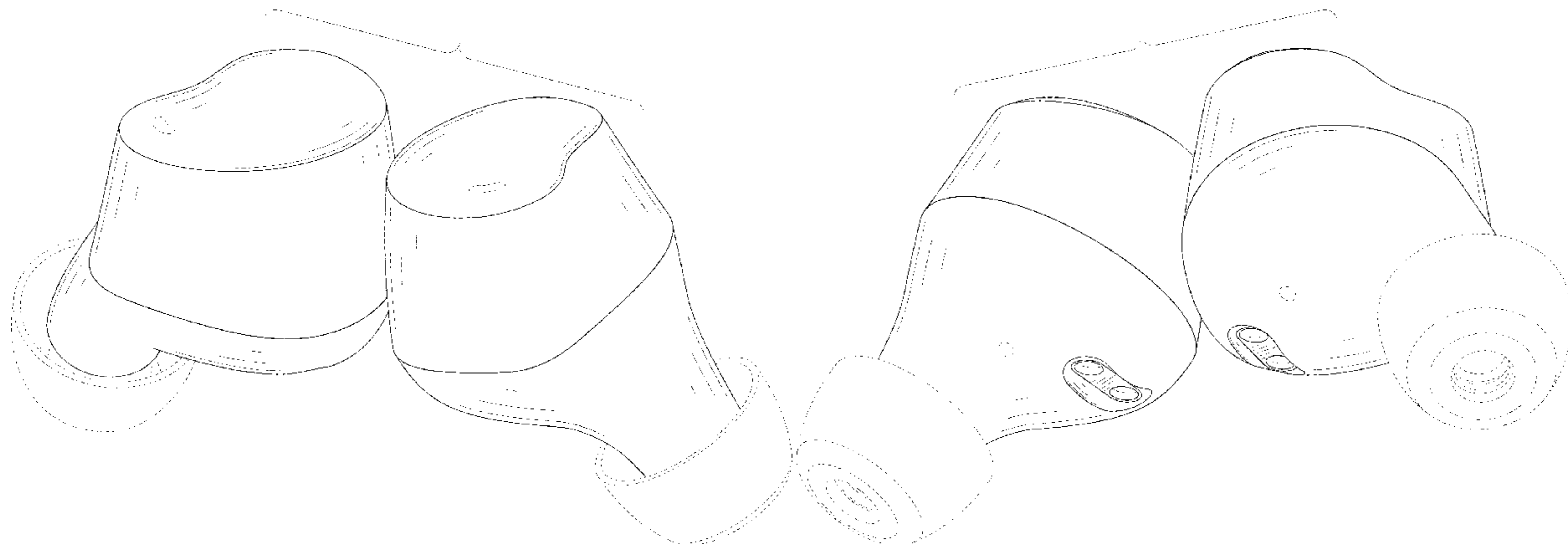
(57) **CLAIM**

The ornamental design for earphones, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of earphones showing my new design;  
FIG. 2 is another perspective view thereof;  
FIG. 3 is a front elevational view thereof;  
FIG. 4 is a rear elevational view thereof;  
FIG. 5 is a left side elevational view thereof;  
FIG. 6 is a right side elevational view thereof;  
FIG. 7 is a top plan view thereof;  
FIG. 8 is a bottom plan view thereof; and,  
FIG. 9 is a perspective view of the earphones where the earphones are received in a charging case.  
The broken lines in the drawings depict portions of the earphones that form no part of the claimed design.

**1 Claim, 9 Drawing Sheets**



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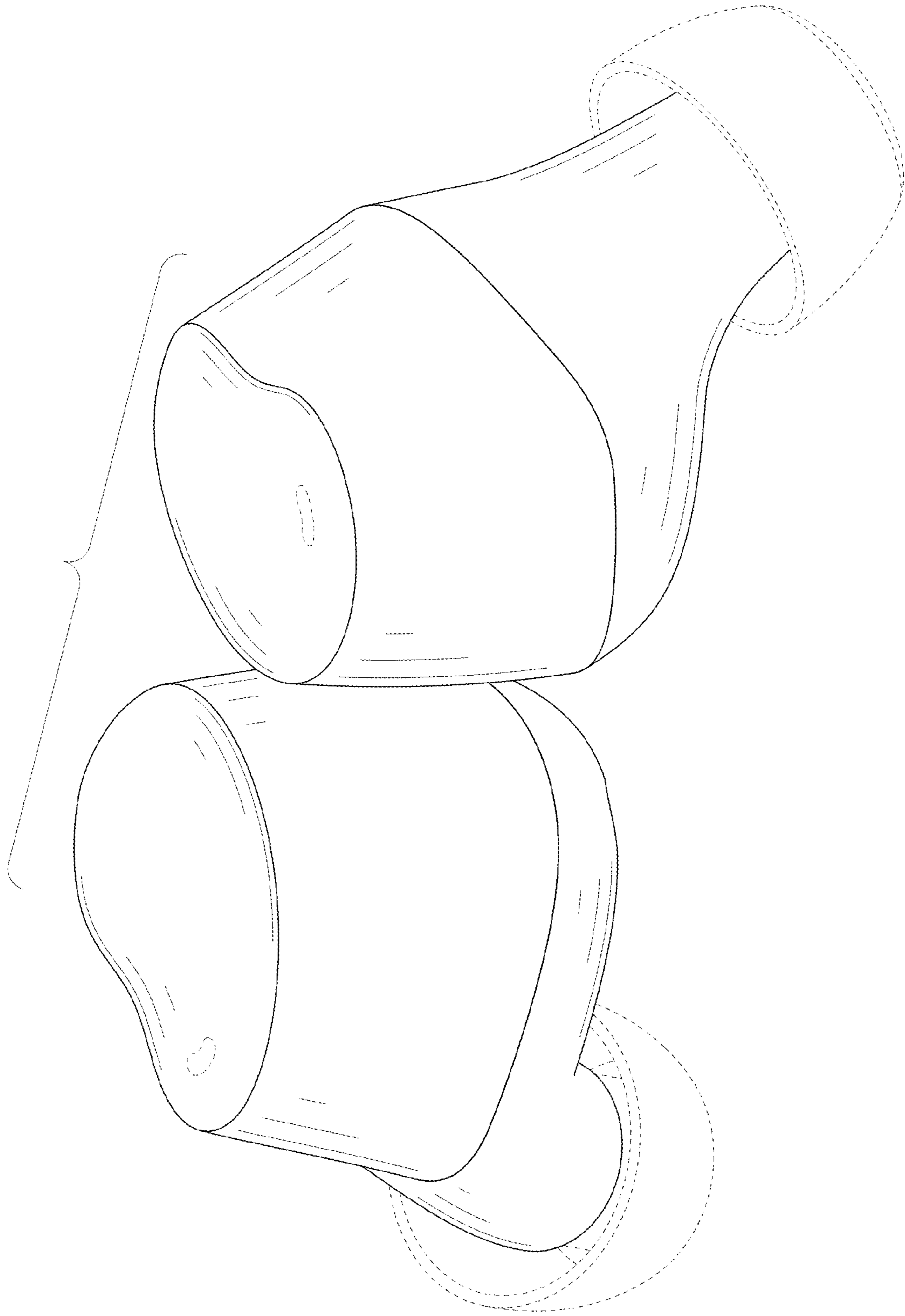


FIG. 1

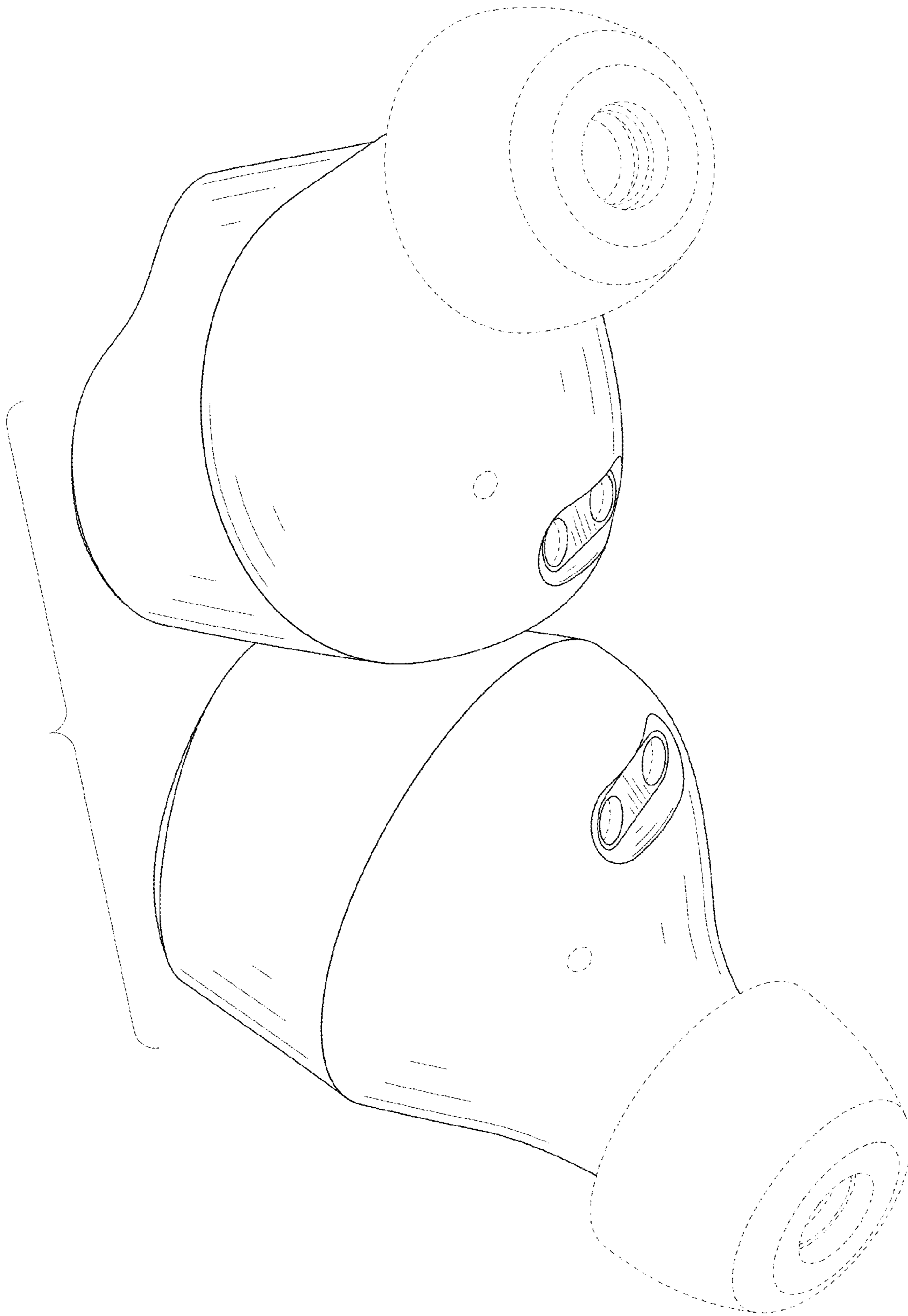


FIG. 2



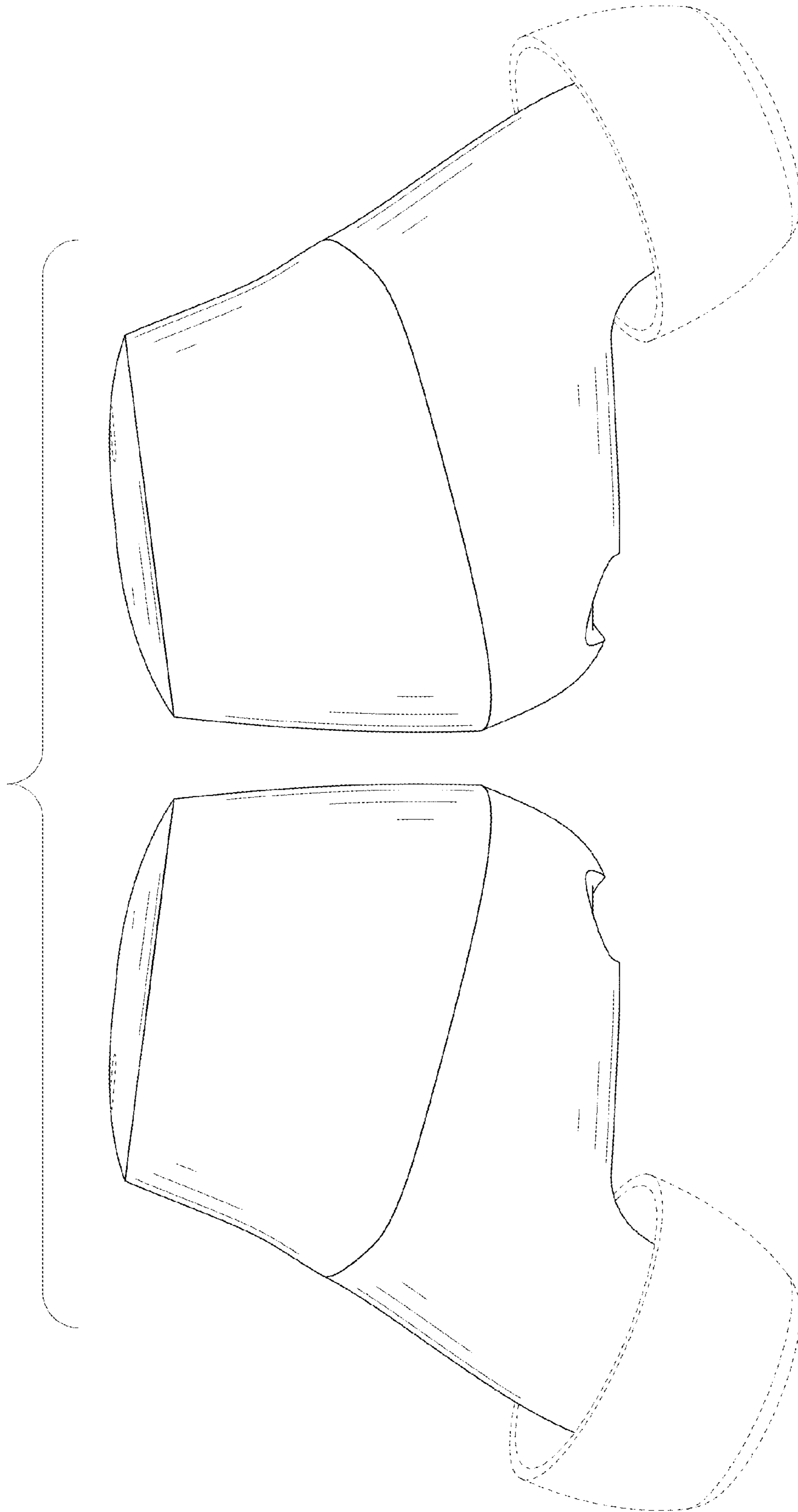


FIG. 3

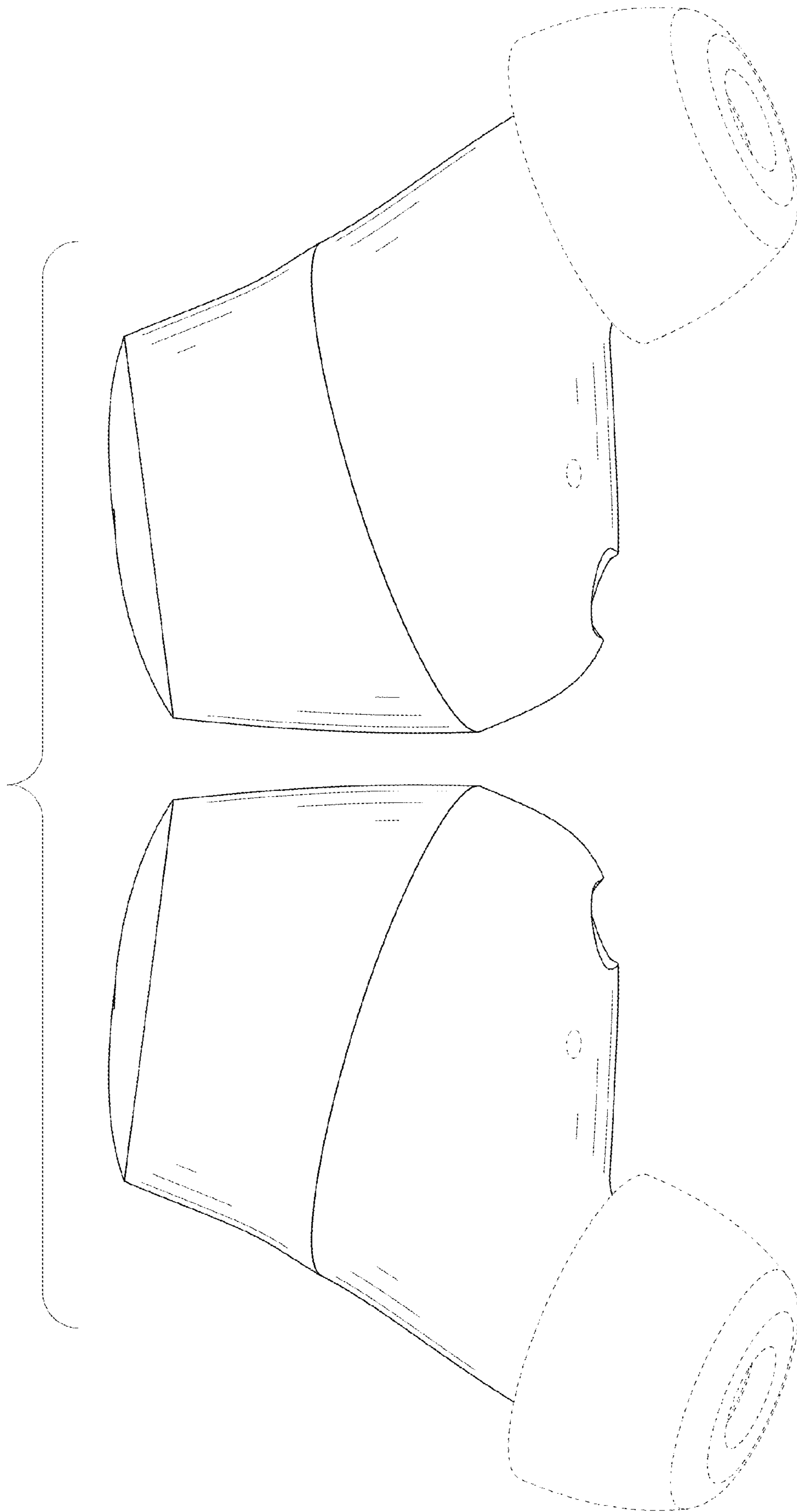


FIG. 4

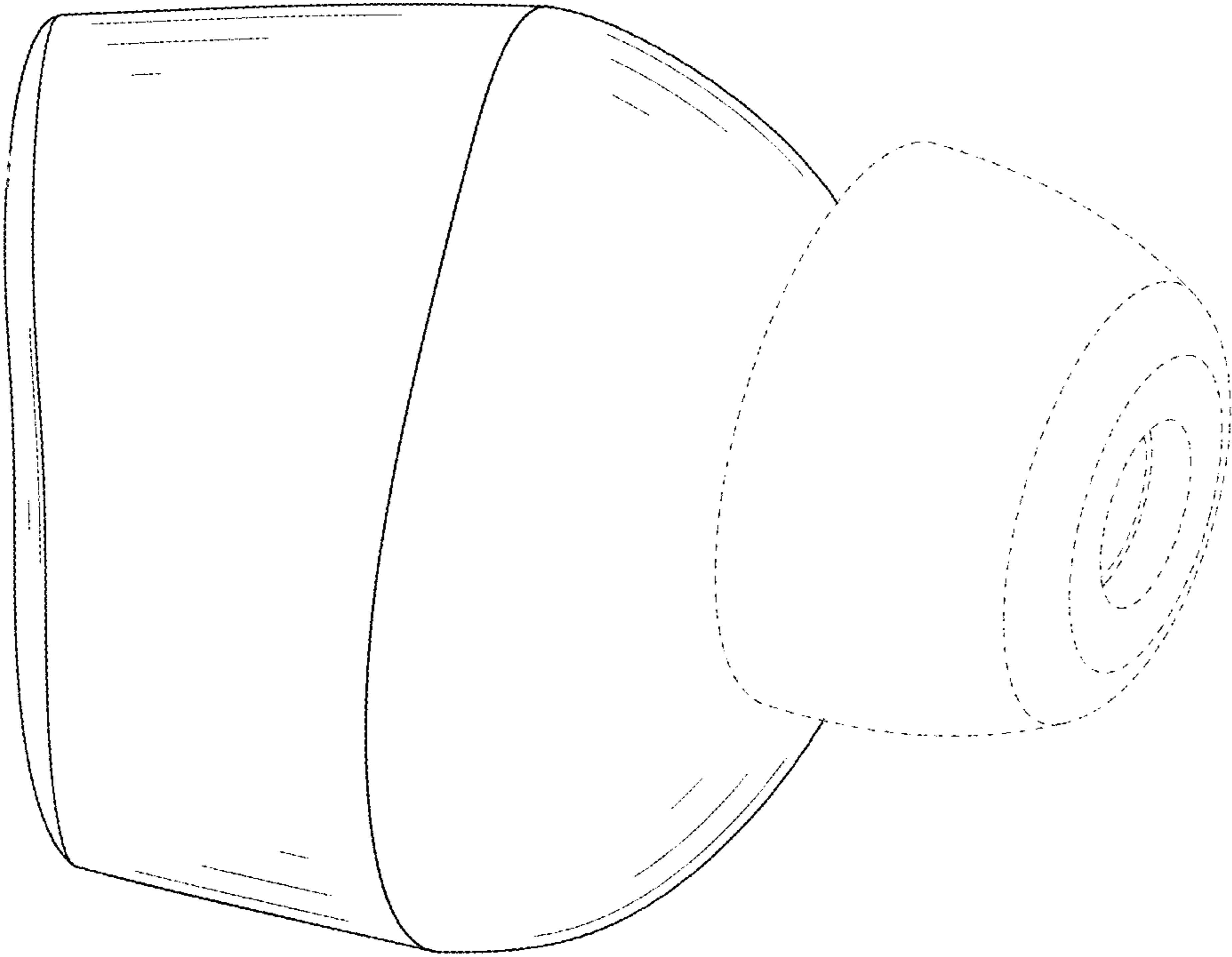


FIG. 5

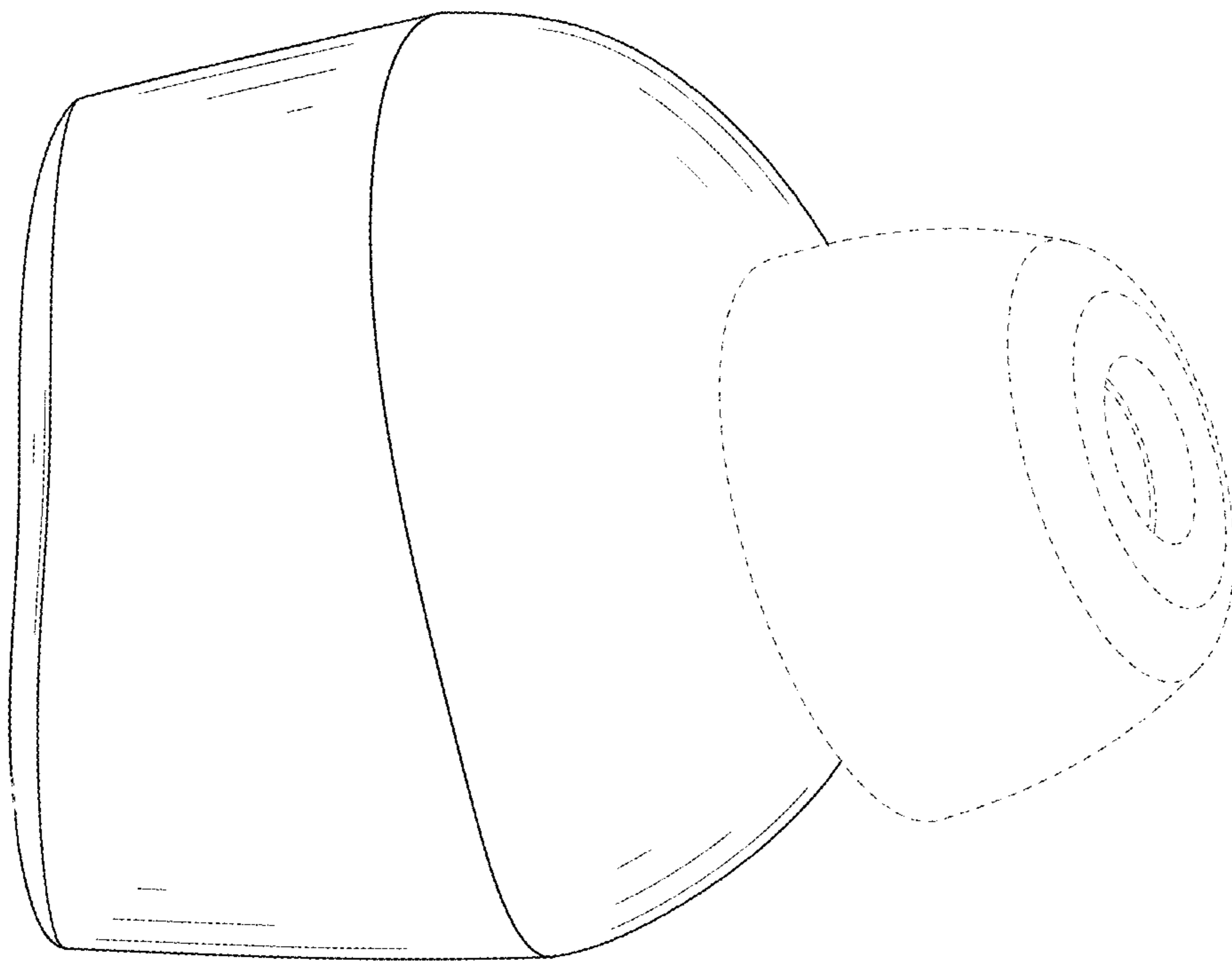


FIG. 6



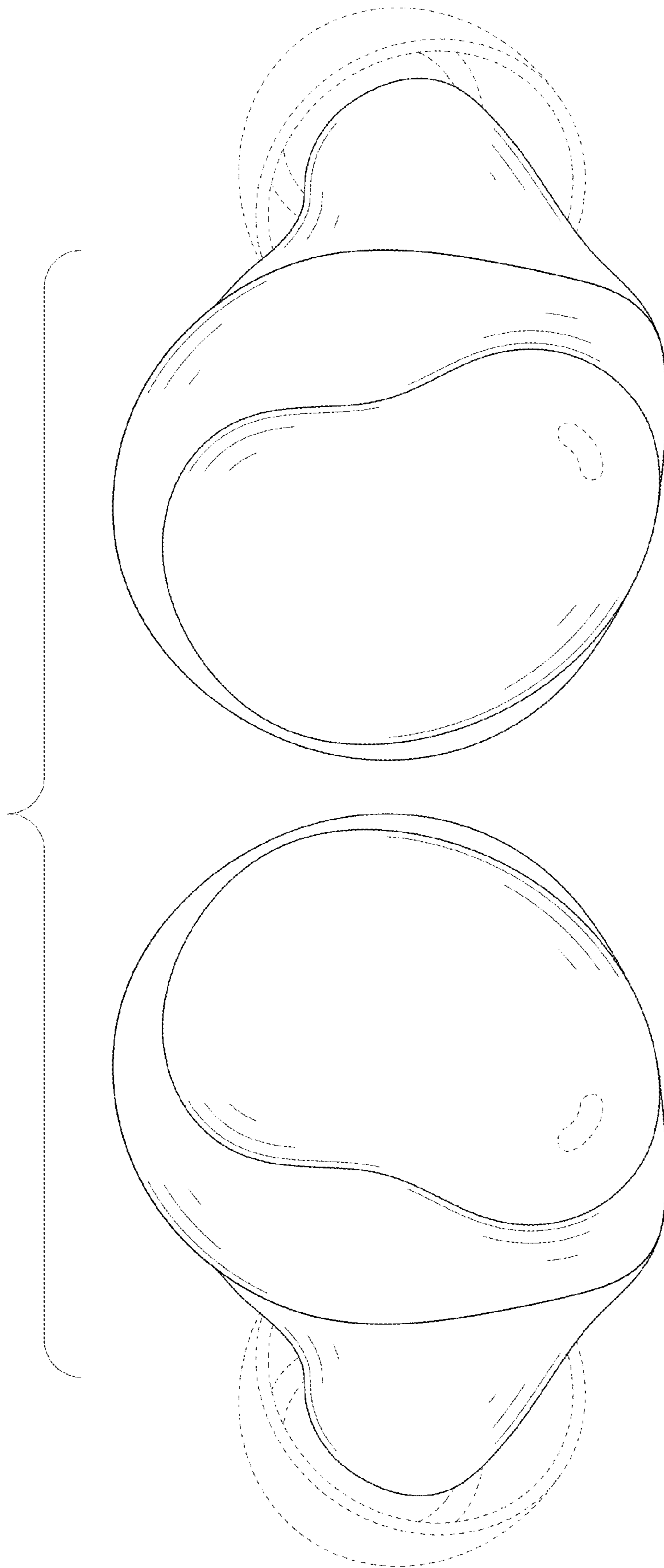


FIG. 7

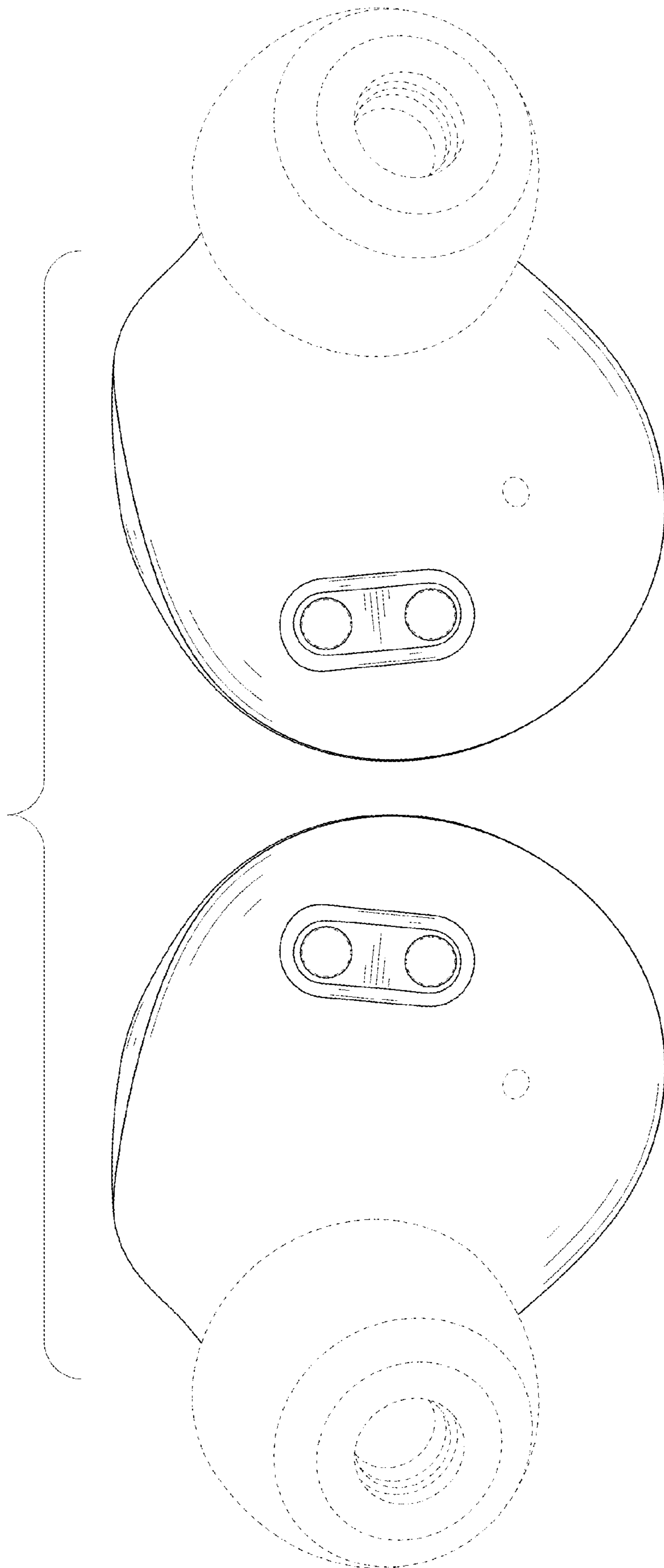


FIG. 8

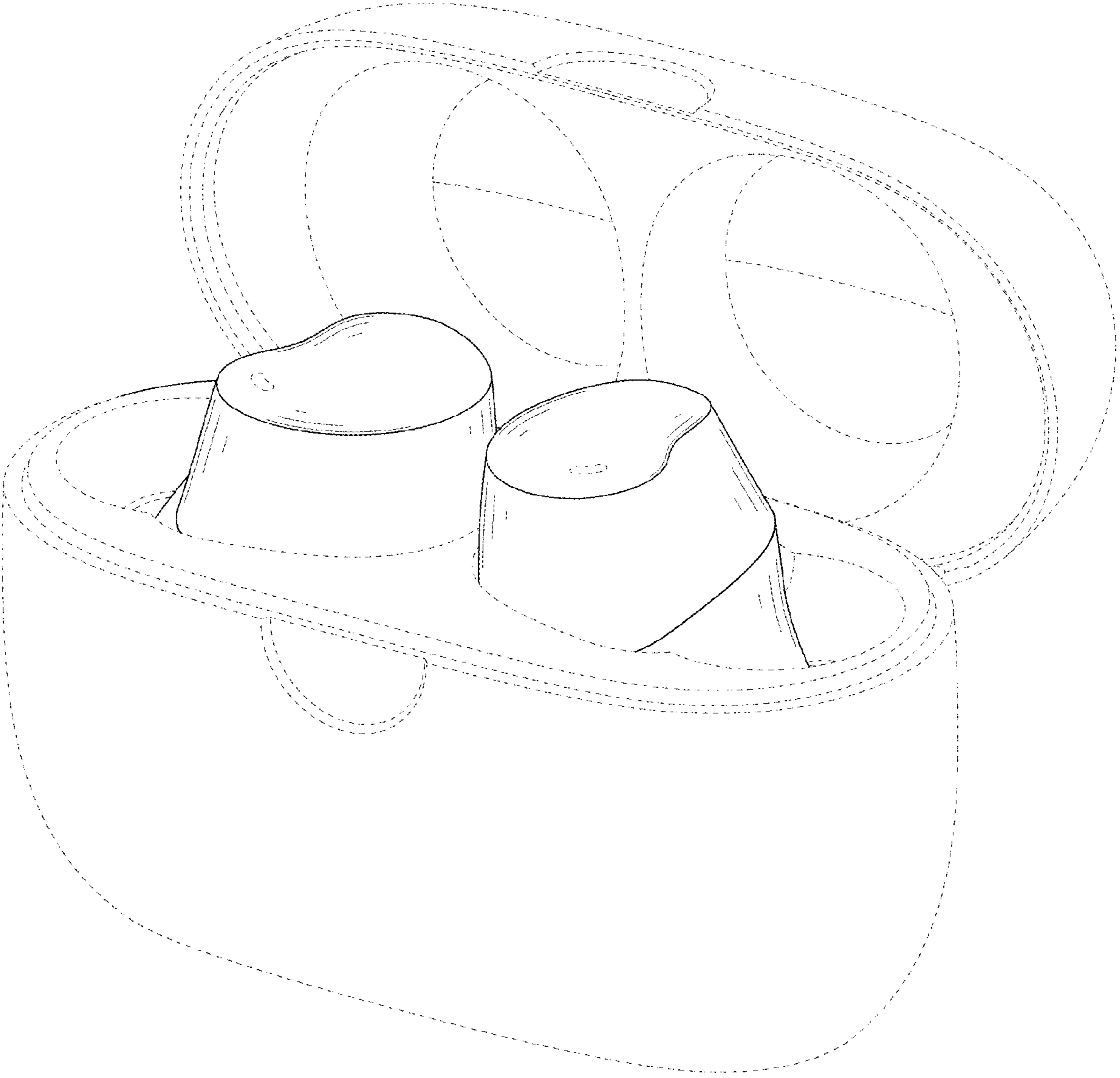


FIG. 9